Stackpole Electronics, Inc.

Gold Barrier Thick Film Chip Resistors

Resistive Product Solutions

Features:

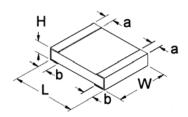
- Gold terminations are completely impervious to sulfur
- Zero ohm available (max resistance 0.05Ω)
- RoHS compliant and halogen free
- REACH compliant



| Electrical Specifications | | | | | | |
|---------------------------|---|--|------------------------------------|-----------------|---|-----------|
| Type / Code | Power Rating (W) @ 70°C | Maximum Working Voltage (V) ⁽¹⁾ | Maximum Overload Voltage (V) | TCR (ppm/°C) | Ohmic Range (Ω) and Tolerance 1% 2%, 5% | |
| | | i conseque (a) | 9 () | -0/+600 | | 3.6 |
| | | | | ± 350 | 3.9 | |
| RMCG0402 | 0.1 | 50 | 100 | ± 200 | | · 1M |
| | | | | ± 350 | 1.1M - 10M | |
| | | | | ± 350 | 1 - 9.1 | |
| RMCG0603 | 0.1 | 50 | 100 | ± 200 | | · 1M |
| | • | | | ± 350 | | - 10M |
| | | | | ± 350 | | 3.6 |
| | | | | ± 250 | 3.9 | |
| RMCG0805 | 0.125 | 150 | 300 | ± 200 | | · 1M |
| | 0.120 | 100 | 300 | ± 250 | 1.1M - 5.1M | |
| | | | | ± 350 | 5.6M | - 10M |
| | | | | ± 350 | 1 - | 3.6 |
| | 0.25 | 200 | | ± 250 | 3.9 - 9.1 | |
| RMCG1206 | | | 400 | ± 200 | 10 - 1M | |
| | | | | ± 250 | 1.1M - 5.1M | |
| | | | | ± 350 | 5.6M - 10M | |
| | | | | ± 350 | 1 - 3.6 | |
| | 0.33 | 200 | 400 | ± 250 | 3.9 - 9.1 | |
| RMCG1210 | | | | ± 200 | | · 1M |
| | | | | ± 250 | | - 5.1M |
| | | | | ± 350 | 5.6M | - 10M |
| | 0.75 | 200 | 400 | ± 350 | 1 - 2 | 1 - 3.6 |
| | | | | ± 250 | 2.2 - 9.1 | 3.9 - 9.1 |
| RMCG2010 | | | | ± 200 | 10 - 1M | |
| | | | | ± 250 | 1.1M - 5.1M | |
| | | | | ± 350 | | - 10M |
| | | 200 | 400 | ± 350 | | 3.6 |
| D14000000 | | | | ± 250 | 3.9 | |
| RMCG2512 | 1 | | | ± 200 | 10 - 1M 1.1M - 5.1M | |
| | | | | ± 250 | | |
| (4) | <u> </u> | | | ± 350 | 5.6M | - 10M |

⁽¹⁾ Lesser of √P*R or maximum working voltage.

Mechanical Specifications



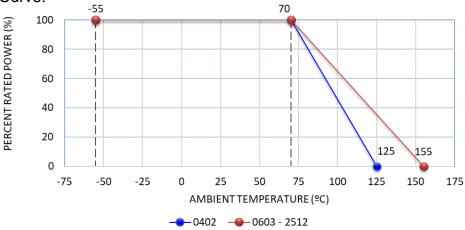
| Type / Code | L Body Length | W Body Width | H Body Height | a Top Termination | b Bottom Termination | Unit |
|-------------|------------------|-------------------|------------------|----------------------|-------------------------|--------|
| RMCG0402 | 0.039 ± 0.002 | 0.020 ± 0.002 | 0.014 ± 0.002 | 0.008 ± 0.004 | 0.010 ± 0.004 | inches |
| | 1.00 ± 0.05 | 0.50 ± 0.05 | 0.35 ± 0.05 | 0.20 ± 0.10 | 0.25 ± 0.10 | mm |
| RMCG0603 | 0.063 ± 0.004 | 0.031 ± 0.004 | 0.018 ± 0.004 | 0.012 ± 0.008 | 0.012 ± 0.008 | inches |
| | 1.60 ± 0.10 | 0.80 ± 0.10 | 0.45 ± 0.10 | 0.30 ± 0.20 | 0.30 ± 0.20 | mm |
| RMCG0805 | 0.079 ± 0.008 | 0.049 ± 0.004 | 0.020 ± 0.006 | 0.016 ± 0.008 | 0.016 ± 0.008 | inches |
| | 2.00 ± 0.20 | 1.25 ± 0.10 | 0.50 ± 0.15 | 0.40 ± 0.20 | 0.40 ± 0.20 | mm |
| RMCG1206 | 0.126 ± 0.008 | 0.063 ± 0.006 | 0.022 ± 0.006 | 0.020 ± 0.010 | 0.020 ± 0.010 | inches |
| | 3.20 ± 0.20 | 1.60 ± 0.15 | 0.55 ± 0.15 | 0.50 ± 0.25 | 0.50 ± 0.25 | mm |
| RMCG1210 | 0.126 ± 0.008 | 0.098 ± 0.008 | 0.022 ± 0.006 | 0.020 ± 0.010 | 0.020 ± 0.010 | inches |
| | 3.20 ± 0.20 | 2.50 ± 0.20 | 0.55 ± 0.15 | 0.50 ± 0.25 | 0.50 ± 0.25 | mm |
| RMCG2010 | 0.197 ± 0.008 | 0.098 ± 0.008 | 0.022 ± 0.006 | 0.024 ± 0.010 | 0.024 ± 0.010 | inches |
| | 5.00 ± 0.20 | 2.50 ± 0.20 | 0.55 ± 0.15 | 0.60 ± 0.25 | 0.60 ± 0.25 | mm |
| RMCG2512 | 0.248 ± 0.008 | 0.126 ± 0.008 | 0.022 ± 0.006 | 0.024 ± 0.010 | 0.024 ± 0.010 | inches |
| | 6.30 ± 0.20 | 3.20 ± 0.20 | 0.55 ± 0.15 | 0.60 ± 0.25 | 0.60 ± 0.25 | mm |

| Performance Characteristics | | | | |
|---------------------------------|---|--------------------------------------|--|--|
| Test | Test Conditions (JIS C 5202) | Test Results | | |
| Short Time Overload | hort Time Overload 2.5x rated voltage for 5 seconds | | | |
| Dielectric Withstanding Voltage | 100 VAC, 1 minute | ± (1% + 0.05 Ω) | | |
| Resistance to Soldering Heat | 260°C ± 5°C, for 10 seconds ± 0.5 seconds (solder bath) | ± (1% + 0.05 Ω) | | |
| Solderability | 245°C ± 5°C, for 3 seconds ± 0.5 seconds (colophonium flux) | 95% coverage, minimum | | |
| Temperature Cycle (100 cycles) | -55°C: 30 minutes 25°C: 2 to 3 minutes 125°C: 30 minutes 25°C: 2 to 3 minutes | ± (1% + 0.05 Ω) Jumper (< 0.05 Ω) | | |
| Endurance (Damp load) | 60°C ± 2°C, 90% RH, Rated Load 90 minutes On, 30 minutes Off (1000 hours -0 hours +48 hours) | ± (3% + 0.1 Ω) Jumper (< 0.05 Ω) | | |
| Endurance (Rated load) | 70°C ± 2°C, Rated Load 90 minutes On, 30 minutes Off (1000 hours -0 hours +48 hours) | ± (3% + 0.1 Ω) Jumper (< 0.05 Ω) | | |
| Voltage Coefficient | 1/10 rated voltage for 3 second, then rated voltage for 3 seconds | ± 100 (ppm/V) | | |
| Robustness of Termination | Bend of 3 mm for 5 ± 1 seconds | ± (1% + 0.05 Ω) | | |

Operating Temperature Range: -55°C to +125°C (0402)

-55°C to +155°C (0603 - 2512)

Power Derating Curve:



Recommended Solder Profile

This information is intended as a reference for solder profiles for Stackpole resistive components. These profiles should be compatible with most soldering processes. These are only recommendations. Actual numbers will depend on board density, geometry, packages used, etc., especially those cells labeled with "*".

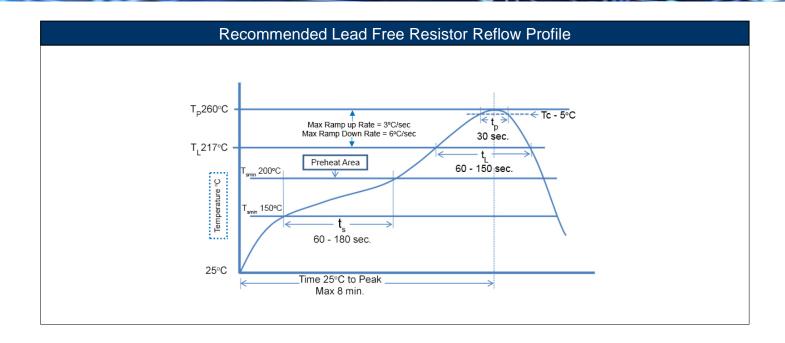
100% Matte Tin / RoHS Compliant Terminations

Soldering iron recommended temperatures: 330°C to 350°C with minimum duration. Maximum number of reflow cycles: 3.

| Wave Soldering | | | | | |
|--------------------|------------|-------------|------------|--|--|
| Description | Maximum | Recommended | Minimum | | |
| Preheat Time | 80 seconds | 70 seconds | 60 seconds | | |
| Temperature Diff. | 140°C | 120°C | 100°C | | |
| Solder Temp. | 260°C | 250°C | 240°C | | |
| Dwell Time at Max. | 10 seconds | 5 seconds | * | | |
| Ramp DN (°C/sec) | N/A | N/A | N/A | | |

Temperature Diff. = Defference between final preheat stage and soldering stage.

| Convection IR Reflow | | | | | |
|----------------------|-------------|-------------|------------|--|--|
| Description | Maximum | Recommended | Minimum | | |
| Ramp Up (°C/sec) | 3°C/sec | 2°C/sec | * | | |
| Dwell Time > 217°C | 150 seconds | 90 seconds | 60 seconds | | |
| Solder Temp. | 260°C | 245°C | * | | |
| Dwell Time at Max. | 30 seconds | 15 seconds | 10 seconds | | |
| Ramp DN (°C/sec) | 6°C/sec | 3°C/sec | * | | |



RoHS Compliance

Stackpole Electronics has joined the worldwide effort to reduce the amount of lead in electronic components and to meet the various regulatory requirements now prevalent, such as the European Union's directive regarding "Restrictions on Hazardous Substances" (RoHS 3). As part of this ongoing program, we periodically update this document with the status regarding the availability of our compliant components. All our standard part numbers are compliant to EU Directive 2011/65/EU of the European Parliament as amended by Directive (EU) 2015/863/EU as regards the list of restricted substances.

| RoHS Compliance Status | | | | | | | |
|-------------------------------|--|----------------------------------|---|--------------------------------------|--|--|--|
| Standard Product Series | Description | Package / Termination Type | Standard Series RoHS Compliant | Lead-Free Termination Composition | Lead-Free Mfg. Effective Date (Std Product Series) | Lead-Free Effective Date Code (YY/WW) | |
| RMCG | Gold Barrier Thick Film Surface Mount Chip Resistor | SMD | YES(1) | 100% Matte Sn over Ni | Jan-06 | 06/01 | |

Note (1): RoHS Compliant by means of exemption 7c-I.

"Conflict Metals" Commitment

We at Stackpole Electronics, Inc. are joined with our industry in opposing the use of metals mined in the "conflict region" of the Eastern Democratic Republic of the Congo (DRC) in our products. Recognizing that the supply chain for metals used in the electronics industry is very complex, we work closely with our own suppliers to verify to the extent possible that the materials and products we supply do not contain metals sourced from this conflict region. As such, we are in compliance with the requirements of Dodd-Frank Act regarding Conflict Minerals.

Compliance to "REACH"

We certify that all passive components supplied by Stackpole Electronics, Inc. are SVHC (Substances of Very High Concern) free and compliant with the requirements of EU Directive 1907/2006/EC, "The Registration, Evaluation, Authorization and Restriction of Chemicals", otherwise referred to as REACH. Contact us for complete list of REACH Substance Candidate List.

Environmental Policy

It is the policy of Stackpole Electronics, Inc. (SEI) to protect the environment in all localities in which we operate. We continually strive to improve our effect on the environment. We observe all applicable laws and regulations regarding the protection of our environment and all requests related to the environment to which we have agreed. We are committed to the prevention of all forms of pollution.

